



PRODUCT DATASHEET Strada-SQ series last update 22/12/2011



Ordering number Description	C11816 C11816_Strada-SQ-T-DN-XP		
Family	Strada-SQ	FWHM	Asym degrees
Туре	Lens	Efficiency	87 %
LED	XP-E	cd/lm	-
Color	Transparent	Gerber File	Available
Diameter	25 + 25 mm		
Height	8.77 mm		
Style	Square		
Optic Material	PMMA		
Holder Material	-		
Fastening	Screw, glue		
Status	Ready		
Ordering number	CA11817 CA11817_Strada-SQ-T-DN-XP-TAPE		
Description		P-TAPE	
		P -TAPE FWHM	Asym degrees
Description	CA11817_Strada-SQ-T-DN-XI		Asym degrees 87 %
Description Family	CA11817_Strada-SQ-T-DN-XI Strada-SQ	FWHM	, 0
Description Family Type	CA11817_Strada-SQ-T-DN-XI Strada-SQ Lens	FWHM Efficiency	, 0
Description Family Type LED	CA11817_Strada-SQ-T-DN-XI Strada-SQ Lens XP-E	FWHM Efficiency cd/lm	87 % -
Description Family Type LED Color	CA11817_Strada-SQ-T-DN-XI Strada-SQ Lens XP-E Transparent	FWHM Efficiency cd/lm	87 % -
Description Family Type LED Color Diameter	CA11817_Strada-SQ-T-DN-XI Strada-SQ Lens XP-E Transparent 25 + 25 mm	FWHM Efficiency cd/lm	87 % -
Description Family Type LED Color Diameter Height	CA11817_Strada-SQ-T-DN-XI Strada-SQ Lens XP-E Transparent 25 + 25 mm 8.92 mm	FWHM Efficiency cd/lm	87 % -
Description Family Type LED Color Diameter Height Style	CA11817_Strada-SQ-T-DN-XI Strada-SQ Lens XP-E Transparent 25 + 25 mm 8.92 mm Square	FWHM Efficiency cd/lm	87 % -
Description Family Type LED Color Diameter Height Style Optic Material	CA11817_Strada-SQ-T-DN-XI Strada-SQ Lens XP-E Transparent 25 + 25 mm 8.92 mm Square	FWHM Efficiency cd/lm	87 % -
Description Family Type LED Color Diameter Height Style Optic Material Holder Material	CA11817_Strada-SQ-T-DN-XI Strada-SQ Lens XP-E Transparent 25 + 25 mm 8.92 mm Square PMMA -	FWHM Efficiency cd/lm	87 % -

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NOTE: The typical divergence will be changed by different color, chip size and chip position tolerance. The typical total divergence is the full angle measured where the luminous intensity is half of the peak value.

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GENERAL INFORMATION

- Product series especially designed & optimized for XP-E series of LEDs.

- Special care taken to make light distribution as uniform as possible.

- Fastening to heat sink with a PU foam adhesive tape of automotive grade. Please find fastening details by clicking link: http://www.ledil.com/datasheets/DataSheet_TAPE.pdf

- Fastening to PCB with appropriate adhesive. By clicking link below you can find Ledil recommended glue options.

http://www.ledil.com/datasheets/DataSheet_GLUES.pdf

NOTE 1: We advise customer to ensure the suitability and sufficiency of the bond in the end product. For example, mechanical stress, vibration and holes on the surface of the circuit boar weaken the strength of the tape.

NOTE 2: Assembly to the surface must be made straight, so the tape bonds constant and balanced with fastening surface. Slanted assembly might cause unbalanced bond to the surface. All surfaces where tape is applied must be clean, dry and free from grease and dirt.

If cleaning of PCB surfaces is needed, please follow strictly the cleaning instructions of your LED manufacturer - this is important as cleaning shall under no circumstances damage LEDs or other electronics components on the PCB.

Further note that optical components shall not be cleaned with any chemicals - only micro fiber cloth may be used to remove fingerprints or other traces from handling.

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